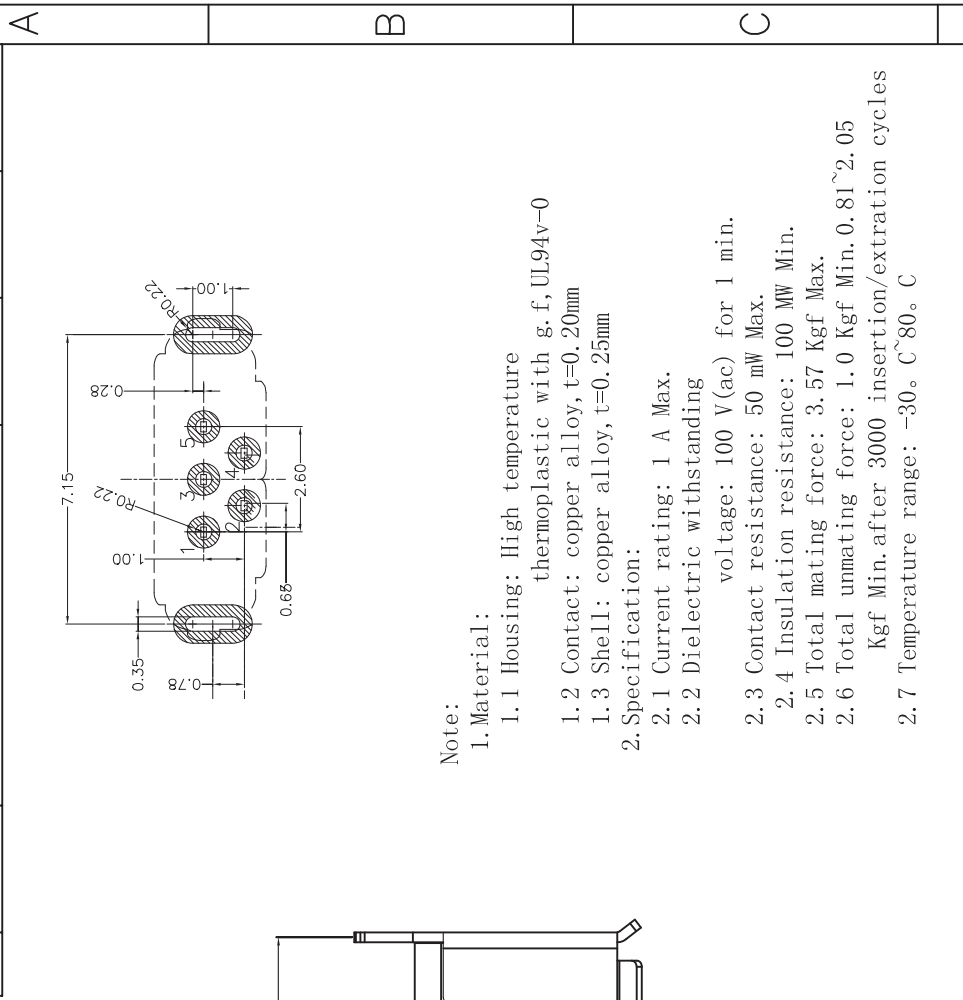


4		5			
REV	ECNNO.	DESCRIPTION	DRWN	APPD.	DATE.



Note:

1. Material:
 - 1.1 Housing: High temperature thermoplastic with g. f, UL94v-0
 - 1.2 Contact: copper alloy, t=0.20mm
 - 1.3 Shell: copper alloy, t=0.25mm
2. Specification:
 - 2.1 Current rating: 1 A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 50 mW Max.
 - 2.4 Insulation resistance: 100 MW Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min. 0.81~2.05 Kgf Min. after 3000 insertion/extraction cycles
 - 2.7 Temperature range: -30. C~80. C

UNITS		SCALE		DONGDUAN DEALON ELECTRONICS CO.,LTD	
MM		1:1		MICRO 5P/F B TYPE 180插板	
GENERAL TOLERANCE		DR. Aaron		TITLE:	
X. ±0.30	X.X ±0.20	CHK. Aaron		MATERIAL: USB-MR-D-030	
X.XX ±0.10	X.X ±3°	APPD. PANYUFENG		DATE: 2013.01.28	
X.X ±2°		PARTNO: GLF-MICRO-0330		SIZE A4	
4		5		6	